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U.S.	Departme	ent of Commerce, Pate	ent and Trademarl	k Office	Attorne	y Dock	et No.:	Application No.:	
					CIS02	11US		10/782,314	
INFORMATION DISCLOSURE STATEMENT BY APPLICANT					Applicant(s):			Confirmation No.	
(Use several sheets if necessary)					Smith et al.			7633	
		Filing Date:			Group Art Unit:				
					Februar	y 19, 2	004	4121	
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	AD	5,978,852	Nov. 1999	Myrick et al.		709	238	+	
	AE	6,058,238	July 2000	Yuasa et al.		709	223	+	
	AF	6,064,671	May 2000	Killian		370	389	+	
	AG	6,181,681	Jan. 2001	Hiscock et al.		370	279		
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ī	AQ	2002/0146008	Oct. 2002	Kaplan		370	390		
	AR	2002/0186654	Dec. 2002	Tornar		370	225		
	AS	2003/0110344	June 2003	Szczepanek et a	ıl.	711	100		
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<sup>\*</sup>EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with your communication to applicant.

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INFORMATION DISCLOSURE STATEMENT BY APPLICANT						licant(s):	Confirmation No.	
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	AD	6,657,973	Dec. 2003	Arima		370	254	
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	AN	2004/0105390	June 2004	Saksio		370	245	
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